

标准&定制开关连接器产品制造商 DONG GUAN XI BANG ELECTRONICS CO., LTD.

4 PIN DIP PHOTOTRANSISTOR PHOTOCOUPLER AC INPUT PHOTOCOUPLER EL814 Series



Features

- Compliance Halogens Free (Br < 900 ppm, Cl < 900 ppm, Br+Cl < 1500 ppm)
- AC input response
- Current transfer ratio (CTR: Min. 20% at $I_F = \pm 1 \text{mA}, V_{CE} = 5 \text{V}$)
- High isolation voltage between input and output (Viso = 5000 V rms)
- Wide Operating temperature range -55~110°C
- High collector-emitter voltage V_{CEO} = 80V
- Compact dual-in-line package
- The product itself will remain within RoHS compliant version
- Compliance with EU REACH
- UL and cUL approved (No. E214129)
- VDE approved (No. 132249)
- SEMKO approved
- NEMKO approved
- · DEMKO approved
- FIMKO approved
- CQC approved

Description

The EL814 series of devices each consist of two infrared emitting diodes, connected in inverse parallel, optically coupled to a phototransistor detector.

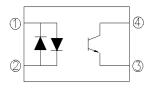
They are packaged in a 4-pin DIP package and available in side-lead spacing and SMD option.

Applications

- AC line monitor
- Programmable controllers
- Telephone line interface
- Unknown polarity DC sensor



Schematic



Pin Configuration

- 1. Anode / Cathode
- 2. Cathode / Anode
- 3. Emitter
- 4. Collector

Absolute Maximum Ratings (Ta=25℃)

	Parameter	Symbol	Rating	Unit
Input	Forward current	l _F	±60	mA
	Peak forward current (t = 10µs)	I _{FM}	1	Α
	Power dissipation	D	100	mW
	Derating factor (above 100 °C)	P _D —	2.9	mW/ºC
	Power dissipation Derating factor (above 100 °C)	P _C —	150	mW
			5.8	mW/ºC
Output	Collector-Emitter voltage	V_{CEO}	80	V
	Emitter-Collector voltage	V_{ECO}	6	V
Total Power Dissipation		P _{TOT}	200	mW
Isolation Voltage*1		V_{ISO}	5000	V rms
Operating Temperature		T _{OPR}	-55 to 110	°C
Storage Temperature		T _{STG}	-55 to 125	°C
Soldering	Temperature* ²	T _{SOL}	260	°C

Notes

^{*1} AC for 1 minute, R.H.= $40 \sim 60\%$ R.H. In this test, pins 1, 2 are shorted together, and pins 3, 4 are shorted together.

^{*2} For 10 seconds

Electro-Optical Characteristics (Ta=25°C unless specified otherwise)

Input

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	VF	-	1.2	1.4	V	$I_F = \pm 20 \text{mA}$
Input capacitance	Cin	-	50	250	pF	V = 0, f = 1KHz

Output

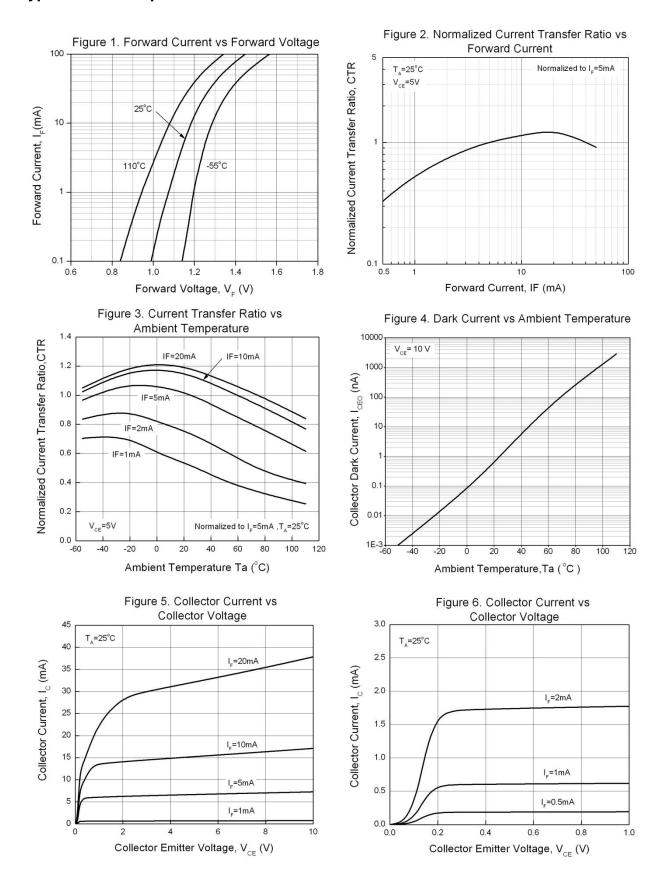
Parameter	Symbol	Min	Тур.	Max.	Unit	Condition
Collector-Emitter dark current	I _{CEO}	-	-	100	nA	V _{CE} = 20V, I _F = 0mA
Collector-Emitter breakdown voltage	BV _{CEO}	80	-	-	V	I _C = 0.1mA
Emitter-Collector breakdown voltage	BV _{ECO}	6	-	-	V	I _E = 0.1mA

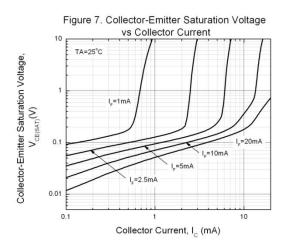
Transfer Characteristics

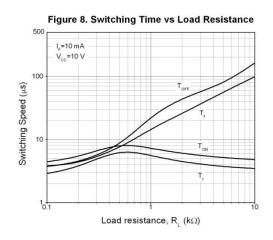
Param	neter	Symbol	Min	Тур.	Max.	Unit	Condition
Current Transfer	EL814	- CTR	20	-	300	%	I 11m
ratio	EL814A	- CIK	50	-	150	/0	$I_F = \pm 1 \text{mA}$, $V_{CE} = 5 \text{V}$
CTR Syr	mmetry		0.7		1.3		$I_F = \pm 1 \text{mA}$, $V_{CE} = 5 \text{V}$
Collector saturation		V _{CE(sat)}	-	0.05	0.2	V	$I_F = \pm 20 \text{mA}$, $I_c = 1 \text{mA}$
Isolation re	esistance	R _{IO}	5×10 ¹⁰	1011	-	Ω	V _{IO} = 500Vdc, 40~60%R.H
Cut-off fre	equency	f _c	-	80	-	kHz	V_{CE} =5V, I_{C} =2 mA, R_{L} =100 Ω , -3dB
Floating ca	pacitance	C _{IO}	-	0.6	1.0	pF	$V_{IO} = 0$, $f = 1MHz$
Rise	time	Tr	-	-	18	μs	V 0V I 0 A D 4000
Fall t	Fall time T _f 18 µs		μs	$V_{CE}=2V$, $I_{C}=2mA$, $R_{L}=100\Omega$			

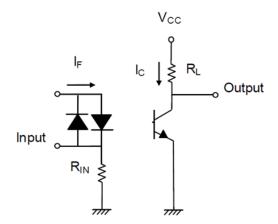
^{*} Typical values at T_a = 25°C

Typical Electro-Optical Characteristics Curves









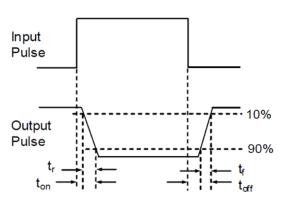


Figure 9. Switching Time Test Circuit & Waveforms

Order Information

Part Number

EL814X(Y)(Z)-V

Notes

= Lead form option (S, S1, M or none)

X Y = CTR Rank (A or none)

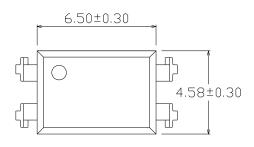
Z V = Tape and reel option (TA, TB, TU, TD or none)

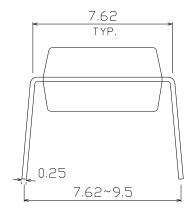
= VDE safety (optional)

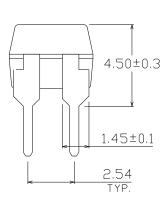
Option	Description	Packing quantity
None	Standard DIP-4	100 units per tube
М	Wide lead bend (0.4 inch spacing)	100 units per tube
S (TA)	Surface mount lead form + TA tape & reel option	1000 units per reel
S (TB)	Surface mount lead form + TB tape & reel option	1000 units per reel
S1 (TA)	Surface mount lead form (low profile) + TA tape & reel option	1000 units per reel
S1 (TB)	Surface mount lead form (low profile) + TB tape & reel option	1000 units per reel
S (TU)	Surface mount lead form + TU tape & reel option	1500 units per reel
S (TD)	Surface mount lead form + TD tape & reel option	1500 units per reel
S1 (TU)	Surface mount lead form (low profile) + TU tape & reel option	1500 units per reel
S1 (TD)	Surface mount lead form (low profile) + TD tape & reel option	1500 units per reel

Package Dimension (Dimensions in mm)

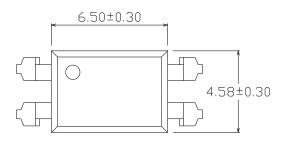
Standard DIP Type

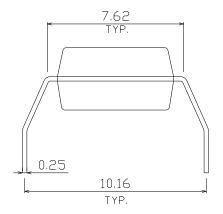


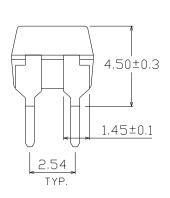




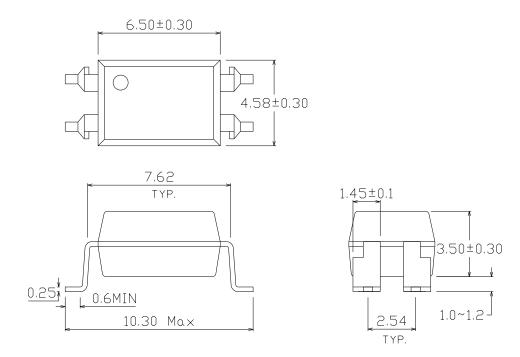
Option M Type



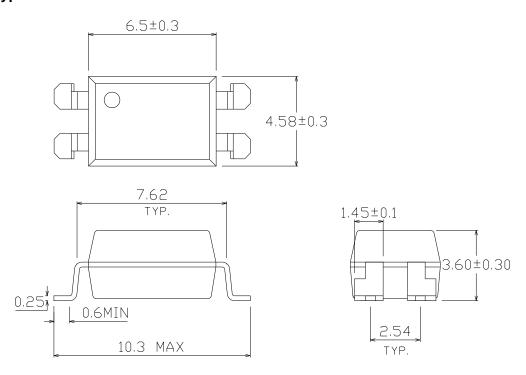




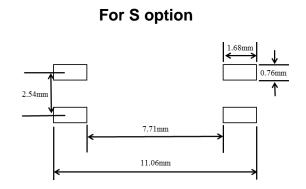
Option S Type

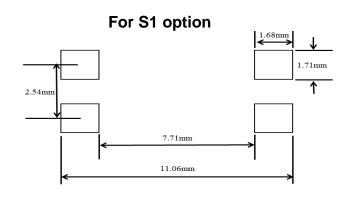


Option S1 Type



Recommended pad layout for surface mount leadform



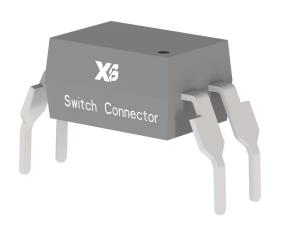


Notes

Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.

Device Marking





Notes

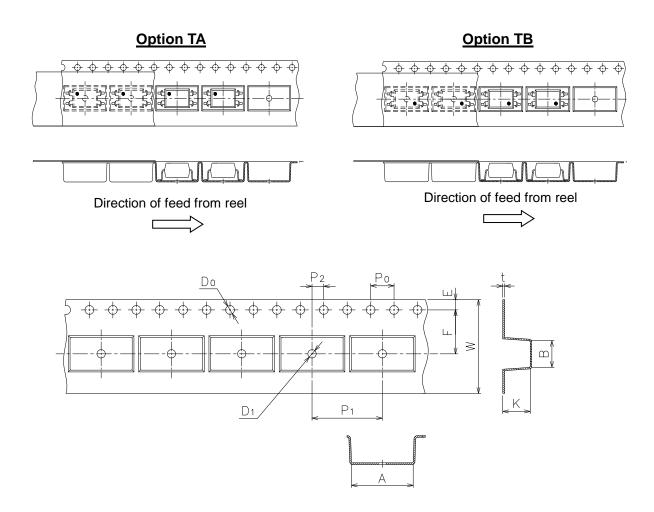
EL denotes XI BNANG 814 denotes Device Number

F denotes Factory Code (G: China and Green part

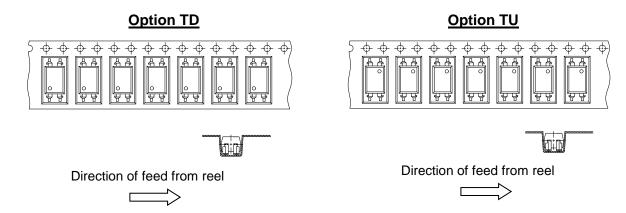
) R denotes CTR Rank (A or none) Y denotes 1 digit Year code WW denotes 2 digit Week code V

denotes VDE (optional)

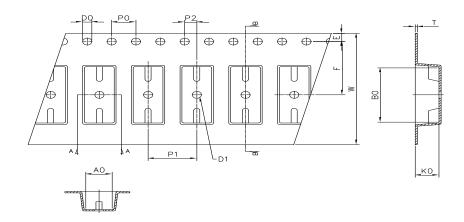
Tape & Reel Packing Specifications



Dimension No.	Α	В	Do	D1	E	F
Dimension (mm) S	10.7±0.1	4.65±0.1	1.5±0.1	1.50±0.1	1.75±0.1	7.5±0.1
Dimension (mm) S1	10.7±0.1	4.65±0.1	1.5±0.1	1.50±0.1	1.75±0.1	7.5±0.1
Dimension No.	Ро	P1	P2	t	W	к
Dimension (mm) S	4.0±0.1	12.0±0.1	2.0±0.1	0.4±0.1	16.0±0.3	4.75±0.1



Tape dimensions

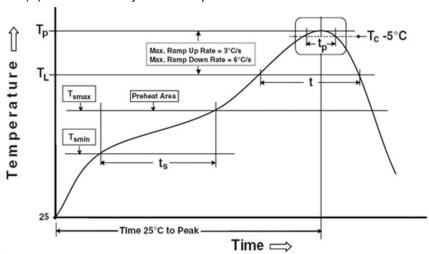


Dimension No.	Ao	Во	Do	D1	E	F
Dimension (mm) S.S1	4.90±0.1	10.40±0.1	1.5±0.1	1.50±0.1	1.75±0.1	7.50±0.1
Dimension No.	Ро	P1	P2	t	w	Ко
Dimension (mm) S.S1	4.00±0.1	8.00±0.1	2.00±0.1	0.40±0.1	16.00±0.3	4.60±0.1

Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Notes Reference: IPC/JEDEC J-STD-020D

Preheat

Temperature min (T _{smin})	150 °C
Temperature max (T _{smax})	200°C
Time $(T_{smin} \text{ to } T_{smax})$ (t_s)	60-120 seconds
Average ramp-up rate (T _{smax} to T _p)	3 °C/second max

Other

Liquidus Temperature (T _L)	217 °C
Time above Liquidus Temperature (t L)	60-100 sec
Peak Temperature (T _P)	260°C
Time within 5 °C of Actual Peak Temperature: T _P - 5°C	30 s
Ramp- Down Rate from Peak Temperature	6°C /second max.
Time 25°C to peak temperature	8 minutes max.
Reflow times	3 times

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